STARPOWER

SEMICONDUCTOR

IGBT

GD100HFL120C2S

Molding Type Module

1200V/100A 2 in one-package

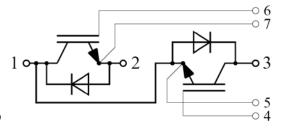
General Description

STARPOWER IGBT Power Module provides ultra low conduction loss as well as short circuit ruggedness. They are designed for the applications such as general inverters and UPS.



Features

- Low V_{CE(sat)} SPT+ IGBT technology
- 10µs short circuit capability
- V_{CE(sat)} with positive temperature coefficient
- Low inductance case
- Fast & soft reverse recovery anti-parallel FWD
- Isolated copper baseplate using DBC technology



Equivalent Circuit Schematic

Typical Applications

- Inverter for motor drive
- AC and DC servo drive amplifier
- Uninterruptible power supply

Absolute Maximum Ratings $T_C=25$ °C unless otherwise noted

Symbol	Description	GD100HFL120C2S	Units
V_{CES}	Collector-Emitter Voltage	1200	V
V_{GES}	Gate-Emitter Voltage	±20	V
T	Collector Current @ T _C =25 ℃	200	
$I_{\rm C}$	@ T _C =100℃	100	A
I _{CM(1)}	Pulsed Collector Current t _p =1ms	200	A
I_{F}	Diode Continuous Forward Current	100	A
I_{FM}	Diode Maximum Forward Current t _p =1ms	200	A
P_{D}	Maximum Power Dissipation @ $T_j=175^{\circ}C$	1000	W
T_{j}	Maximum Junction Temperature	175	$^{\circ}\!\mathbb{C}$
T_{STG}	Storage Temperature Range	-40 to +125	$^{\circ}\!\mathbb{C}$
V _{ISO}	Isolation Voltage RMS,f=50Hz,t=1min	2500	V
Mounting	Power Terminal Screw:M6	2.5 to 5.0	N.m
Torque	Mounting Screw:M6	3.0 to 5.0	N.m

Notes:

Electrical Characteristics of IGBT $T_C=25\,^{\circ}\text{C}$ unless otherwise noted

Off Characteristics

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
V _{(BR)CES}	Collector-Emitter	$T_i=25$ °C	1200			V
	Breakdown Voltage	1 _j =23 C				v
I_{CES}	Collector Cut-Off Current	$V_{CE}=V_{CES}, V_{GE}=0V,$			5.0	mA
		T _j =25℃				ША
I_{GES}	Gate-Emitter Leakage	$V_{GE}=V_{GES}, V_{CE}=0V,$			400	nA
	Current	$T_j=25$ °C			400	

On Characteristics

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$V_{\text{GE(th)}}$	Gate-Emitter Threshold	$I_{C}=4.0$ mA, $V_{CE}=V_{GE}$,	5.0	6.2	7.0	V
	Voltage	$T_j=25^{\circ}C$	3.0			
V _{CE(sat)}		$I_{C}=100A, V_{GE}=15V,$	1.90	2.35		
	Collector to Emitter	$I_{C}=100A, V_{GE}=15V,$ $T_{j}=25^{\circ}C$		1.90	2.33	17
	Saturation Voltage	$I_{C}=100A, V_{GE}=15V,$	2.10		V	
		$I_{C}=100A, V_{GE}=15V,$ $T_{j}=125$ °C		2.10		

⁽¹⁾ Repetitive rating: Pulse width limited by max. junction temperature

Switching Characteristics

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
t _{d(on)}	Turn-On Delay Time			279		ns
t _r	Rise Time			61		ns
t _{d(off)}	Turn-Off Delay Time	V (00VI 100A		308		ns
$t_{\rm f}$	Fall Time	V _{CC} =600V,I _C =100A,		205		ns
Eon	Turn-On Switching Loss	R_{G} =5.6Ω, V_{GE} =±15V, T_{j} =25°C		5.56		mJ
$E_{\rm off}$	Turn-Off Switching Loss			6.95		mJ
t _{d(on)}	Turn-On Delay Time			287		ns
t _r	Rise Time			63		ns
t _{d(off)}	Turn-Off Delay Time	V (00VI 100A		328		ns
$t_{\rm f}$	Fall Time	V_{CC} =600V, I_{C} =100A, R_{G} =5.6 Ω , V_{GE} = \pm 15V, T_{j} =125 $^{\circ}$ C		360		ns
Eon	Turn-On Switching Loss			7.85		mJ
E _{off}	Turn-Off Switching Loss			10.55		mJ
Cies	Input Capacitance			8.58		nF
Coes	Output Capacitance	V_{CE} =25V,f=1MHz, V_{GE} =0V		0.60		nF
C_{res}	Reverse Transfer Capacitance			0.40		nF
I_{SC}	SC Data	$t_{S^{C}} \le 10 \mu s, V_{GE} = 15 V,$ $T_{j} = 125 ^{\circ}\text{C}, V_{CC} = 900 V,$ $V_{CEM} \le 1200 V$		600		A
R _{Gint}	Internal Gate Resistance			5.0		Ω
L _{CE}	Stray Inductance				20	nН
R _{CC'+EE'}	Module Lead Resistance, Terminal to Chip	T _C =25°C		0.35		mΩ

Electrical Characteristics of DIODE $T_C=25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Units
V_{F}	Diode Forward	I 100 A	T _j =25℃		1.82	2.22	V
	Voltage	$I_F=100A$	T _j =125℃		1.95] V
Qr	December Change		T _j =25℃		5.5		C
	Recovered Charge	$I_{F}=100A$,	T _j =125 ℃		11.9		μС
I_{RM}	Peak Reverse	$V_R = 600 \text{V},$	T _j =25℃		85		Δ.
	Recovery Current	di/dt=-2000A/μs,	T _j =125 ℃		103		A
E_{rec}	Reverse Recovery	$V_{GE}=-15V$	T _j =25℃		2.07		m I
	Energy		T _j =125 ℃		5.56		mJ

Thermal Characteristics

Symbol	Parameter	Тур.	Max.	Units
$R_{ heta JC}$	Junction-to-Case (per IGBT)		0.150	K/W
$R_{ heta JC}$	Junction-to-Case (per DIODE)		0.225	K/W
$R_{\theta CS}$	Case-to-Sink (Conductive grease applied)	0.035		K/W
Weight	Weight of Module	300		g

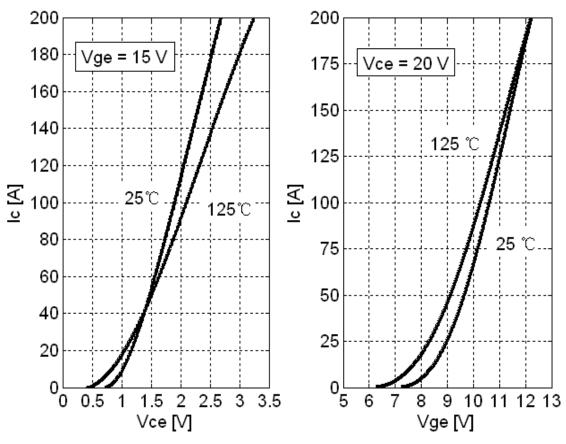


Fig 1. IGBT Typical Output Characteristics Fig 2. IGBT Typical Transfer Characteristics

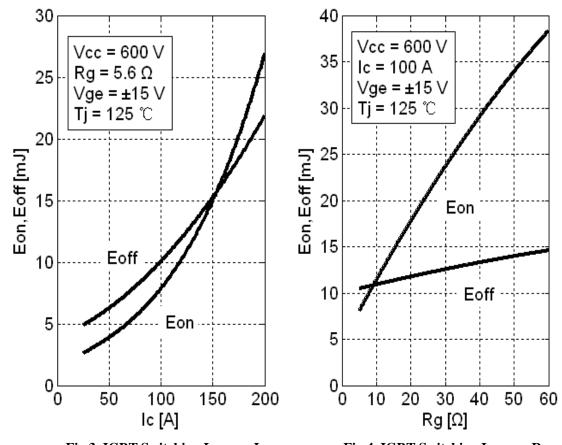


Fig 3. IGBT Switching Loss vs. $I_{\rm C}$

Fig 4. IGBT Switching Loss vs. $R_{\rm G}\,$

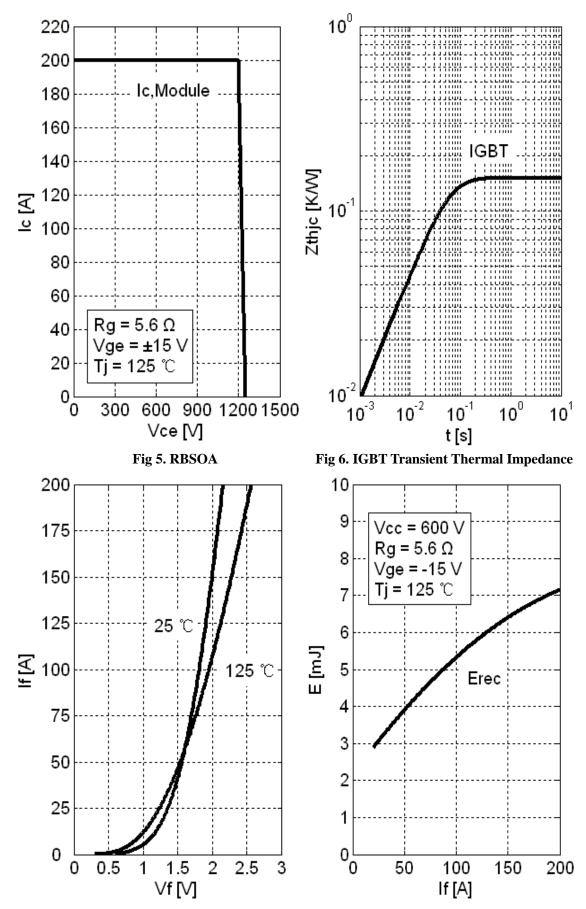


Fig 7. Diode Typical Forward Characteristics

Fig 8. Diode Switching Loss vs. $I_{\rm F}\,$

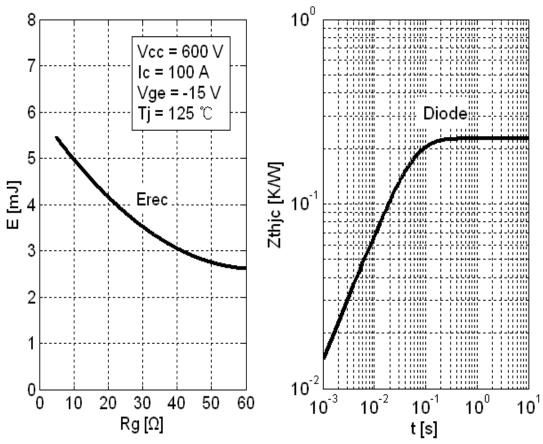
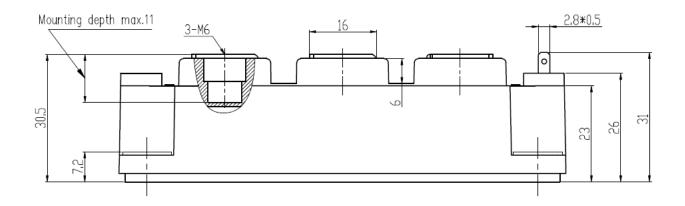


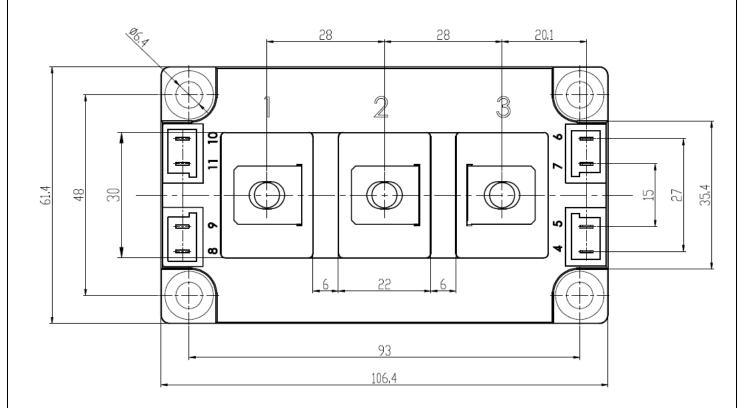
Fig 9. Diode Switching Loss vs. R_G

Fig 10. Diode Transient Thermal Impedance

Package Dimension

Dimensions in Millimeters





GD100HFL120C2S IGBT Module

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